## Declaration and Power of Attorney United States Patent Application

UNITED STATES
Patents and Design Patents
Sole & Joint Inventors
Convention & Non-convention
PCT & Non-PCT
This form cannot be amended, altered
or changed after it is signed.
(For use only for inventors who
understand the English language.)

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

## ELECTROPHOTOSENSITIVE MATERIAL

(check one)	■ is attached here	to.	an an	1 (if annligable) was an	pended on
	□ was filed as PC	5. Application No T International Applicatio	n No	onand (i	f applicable) was amended under
		n			
I have reviewed I acknowledge	and understand the content the duty to disclose information	ts of the above-identified specification which is material to patentab	ation, including the clai oility as defined in Title	ms, as amended by any amend 37, Code of Federal Regulati	ment referred to above. ons, §1.56.
02666 6	DOT intermetional applicati	on which decimated at least one of	country other than the U	inited States of America fisted	eation(s) for patent or inventor's certificate, or in this Declaration. I have also identified of the application(s) on which priority is
claimed:					Priority Claimed? (yes/no)
Foreign/PCT Application No.		Country	Filing Date		
Patent Application		Japan	Sept	ember 24, 2002	Yes
No.2002-277778					
of America list international ap patentability as	ed in this Declaration and,	insofar as the subject matter of eac ovided by the first paragraph of Ti of Federal Regulations, §1.56 whi	ch of the claims of this tle 35, United States C ich became available be	application is not disclosed in ode, §112, I acknowledge the stween the filing date of the pr	tional application designating the United States the prior United States application or PCT duty to disclose information which is material to for application and the national or PCT
U.S. Applica	tion No.	Filing Date	Status	patented/pending/abandoned	?)
		j	j		
		e 35 United States Code §119(e)	of any ITS provisional	application(s) listed below:	
	priority benefits under 1 to onal Application No.	Filing Date	or arry 0.5. provisional	approunding instead of the series	
				4 B 4 4 4 T-44 OF	For connected therewith: Robert G. Weilscher
(20,531), Herb Rodgers (32,9)	oert M. Hanegan (25,682), 36), Michael K. Carrier (42	Dale Lischer (28,438), Frederick 2,391), Eric J. Hanson (44,738), F	F. Calvetti (28,557), J. Patrick R. Delaney (45,	Rodgers Lunsford, III (29,40. 338) and Brandon S. Boss (40	
Send all corre Direct all pho	spondence to: SMITH, G ne calls to (202) 659-2811.	AMBRELL & RUSSELL, LLP,	, 1850 M Street, N.W.	(Suite 800), Washington, D.	C. 20036. All facsimiles may be sent to (202)
be true; and fu Section 1001	other that these statements t	ates Code and that such willful fal	at willful false statemer	its and the like so made are pu	pelief are believed to nishable by fine or imprisonment, or both, under
					Citizenship: Ja
Full name of sole or first inventor: Jun AZUMA  Residence (city, state, country): Osaka-shi, Osaka, Japan					
Post office	address: c/o KYOCI	ERA MITA CORPORAT	ION, 2-28, Tama	tsukuri 1-chome, Chuo	-ku, Osaka-shi, Osaka 540-8585, Japa
Signature:	Jun AZ	VMA	Date: Se	eptember, 16.2003	,
Signature.					
Decidence	(city state country)	tor, if any: Kazunari HAN · Osaka-shi, Osaka, Japan ERA MITA CORPORAT		tsukuri 1-chome, Chuc	Citizenship: J. -ku, Osaka-shi, Osaka 540-8585, Jap
Signature:	Kazunari	HAMASAKI	Se Date:	ptember, 10, 2003	
J		r prior applications are list			SGR/BDWY

## Supplemental Sheet to U.S. Declaration and Power of Attorney (SGR/BDWY-1 supp.)

Full name of third joint inventor it				
Residence (city, state, country); O	f any: Daisuke KUBOSHIM saka-shi, Osaka, Japan A MITA CORPORATION,		Citizenship: Japan Chuo-ku, Osaka-shi, Osaka 540-8585, Japar	
Signature: Daisuke KU Full name of fourth joint inventor, Residence (city, state, country): O Post office address: c/o KYOCER	if any: Hisakazu HONMA saka-shi, Osaka, Japan	·	<mark>). 2003</mark> Citizenship: Japan Chuo-ku, Osaka-shi, Osaka 540-8585, Japan	
Full name of fifth joint inventor, if Residence (city, state, country): O Post office address: c/o KYOCER	any: Saka-shi, Osaka, Japan		Citizenship: Japan Chuo-ku, Osaka-shi, Osaka 540-8585, Japan	
Signature:  Full name of sixth joint inventor, it Residence (city, state, country): Post office address:		Date:	Citizenship:	
Signature:		Date:		
Additional Foreign/PCT Applicat	ions:			
Foreign/PCT Application No.	Country	Filing Date	Priority Claimed? (yes/no)	
Additional U.S. Applications:				
U.S. Application No.	Filing Date	Status (patented/pending/abandoned?)		
Additional Provisional U.S. Appl	lications:			
U.S. Provisional Appli		Filing Date		